CEL

Solid State Relay
OCMOS FET

PS7206-1A

4-PIN SOP, 0.6 Ω LOW ON-STATE RESISTANCE 600 mA CONTINUOUS LOAD CURRENT 1-ch Optical Coupled MOS FET

–NEPOC Series–

DESCRIPTION

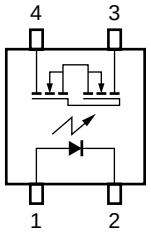
The PS7206-1A is a low on-state resistance solid state relay containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

It is suitable for PLC, etc. because of its large continuous load current and low on-state resistance.

FEATURES

- Low on-state resistance (R_{on} = 0.6 Ω TYP.)
- Large continuous load current (I_L = 600 mA)
- 1 channel type (1 a output)
- Designed for AC/DC switching line changer
- Small and thin package (4-pin SOP, Height = 2.1 mm)
- High isolation voltage (BV = 1 500 Vr.m.s.)
- Low offset voltage
- Ordering number of taping product : PS7206-1A-E3, E4: 900 pcs/reel
  : PS7206-1A-F3, F4: 3 500 pcs/reel
- Pb-Free product
- Safety standards
  - UL approved: No. E72422
  - BSI approved: No. 8241, 8242

PIN CONNECTION
(Top View)



1. LED Anode
2. LED Cathode
3. MOS FET
4. MOS FET

APPLICATIONS

- Measurement equipment
- FA equipment

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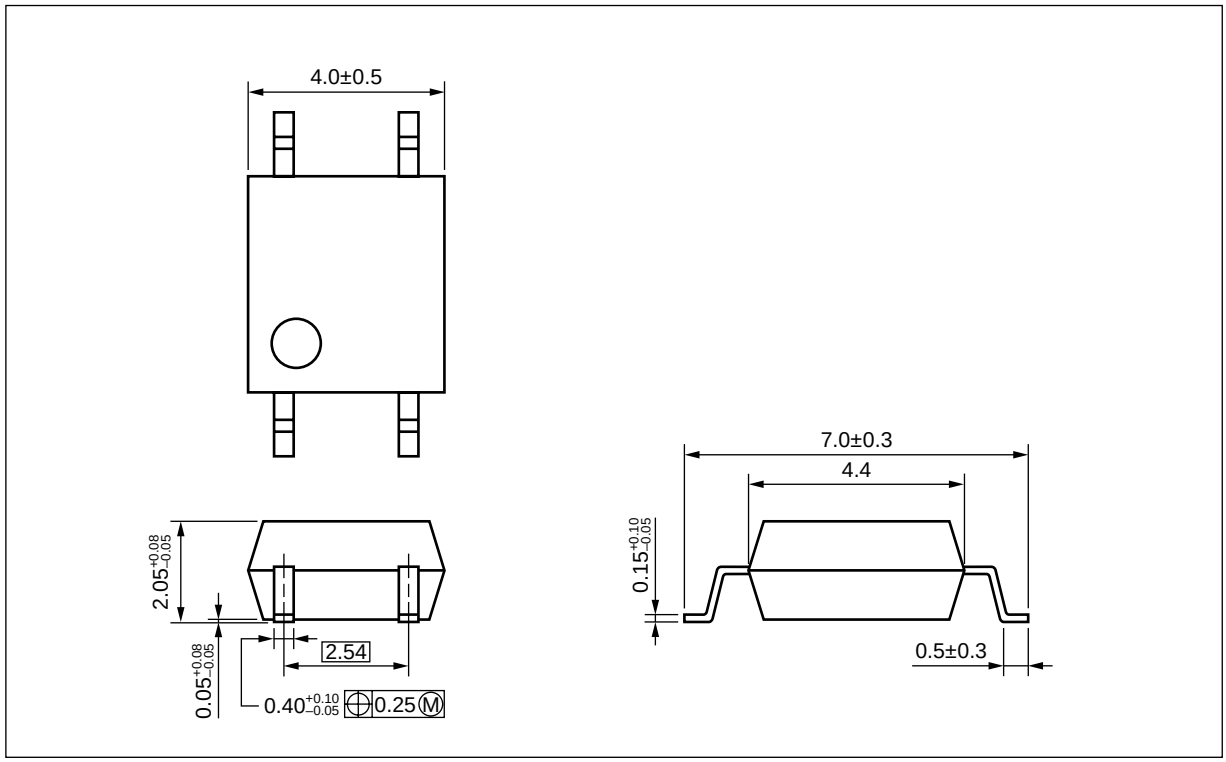
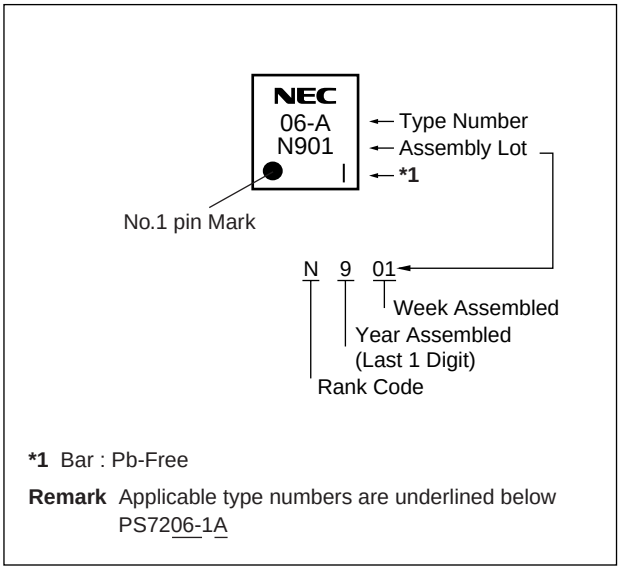
The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PACKAGE DIMENSIONS (UNIT: mm)



<R> MARKING EXAMPLE (LASER MARKING)



***1** Bar : Pb-Free

Remark Applicable type numbers are underlined below
PS7206-1A

ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS7206-1A	PS7206-1A-A	Pb-Free	Magazine case 100 pcs	Standard products (UL, BSI approved)	PS7206-1A
PS7206-1A-E3	PS7206-1A-E3-A		Embossed Tape 900 pcs/reel		
PS7206-1A-E4	PS7206-1A-E4-A				
PS7206-1A-F3	PS7206-1A-F3-A		Embossed Tape 3 500 pcs/reel		
PS7206-1A-F4	PS7206-1A-F4-A				

***1** For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	I_F	50	mA
	Reverse Voltage	V_R	5.0	V
	Power Dissipation	P_D	50	mW
	Peak Forward Current *1	I_{FP}	1	A
MOS FET	Break Down Voltage	V_L	60	V
	Continuous Load Current	I_L	600	mA
	Pulse Load Current *2 (AC/DC Connection)	I_{LP}	1.2	A
	Power Dissipation	P_D	300	mW
Isolation Voltage *3		BV	1 500	Vr.m.s.
Total Power Dissipation		P_T	350	mW
Operating Ambient Temperature		T_A	−40 to +85	°C
Storage Temperature		T_{stg}	−40 to +100	°C

***1** PW = 100 μs, Duty Cycle = 1%

***2** PW = 100 ms, 1 shot

***3** AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.
Pins 1-2 shorted together, 3-4 shorted together.

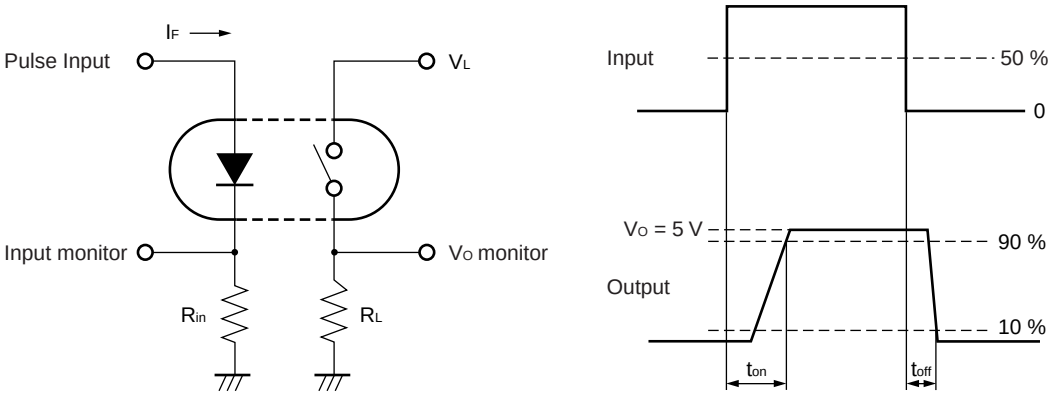
RECOMMENDED OPERATING CONDITIONS (T_A = 25°C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	I_F	2	10	20	mA
LED Off Voltage	V_F	0		0.5	V

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V_F	I_F = 10 mA		1.2	1.4	V
	Reverse Current	I_R	V_R = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	I_{Loff}	V_D = 60 V			1.0	μA
	Output Capacitance	C_{out}	V_D = 0 V, f = 1 MHz		70		pF
Coupled	LED On-state Current	I_{Fon}	I_L = 600 mA			2.0	mA
<R>	On-state Resistance	R_{on1}	I_F = 10 mA, I_L = 100 mA		0.6	0.8	Ω
		R_{on2}	I_F = 10 mA, I_L = 600 mA, t ≤ 10 ms		0.6	0.8	
	Turn-on Time[*1, 2]	t_{on}	I_F = 10 mA, V_O = 5 V, R_L = 500 Ω,		0.4	2.0	ms
	Turn-off Time[*1, 2]	t_{off}	PW ≥ 10 ms		0.08	0.5	
	Isolation Resistance	R_{I-O}	V_{I-O} = 1.0 kV_{DC}	10^9			Ω
	Isolation Capacitance	C_{I-O}	V = 0 V, f = 1 MHz		0.5		pF

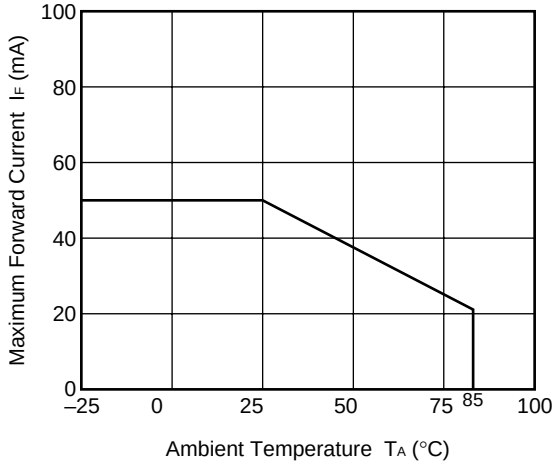
***1** Test Circuit for Switching Time



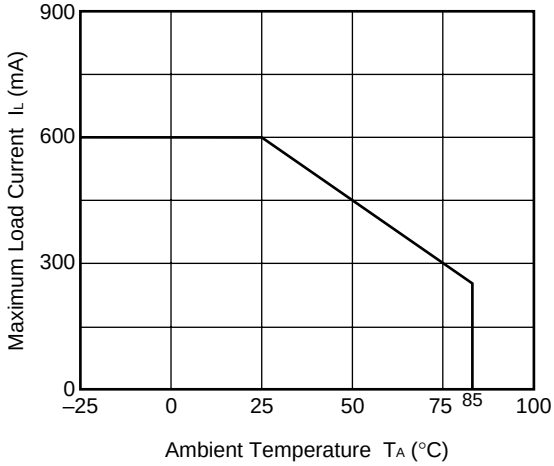
***2** The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.
Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

TYPICAL CHARACTERISTICS (T_A = 25°C, unless otherwise specified)

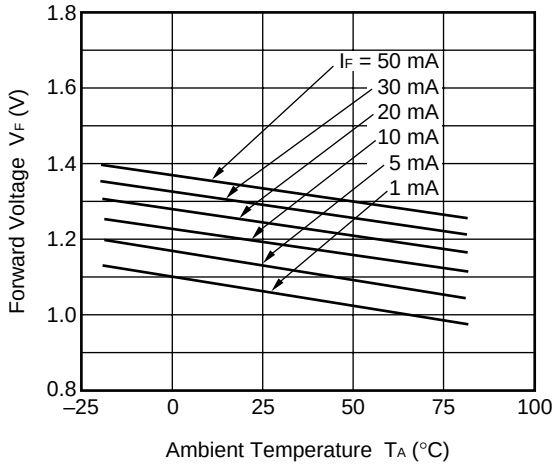
MAXIMUM FORWARD CURRENT vs. AMBIENT TEMPERATURE



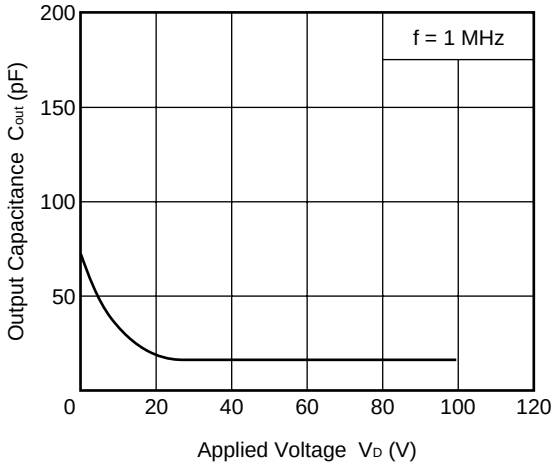
MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



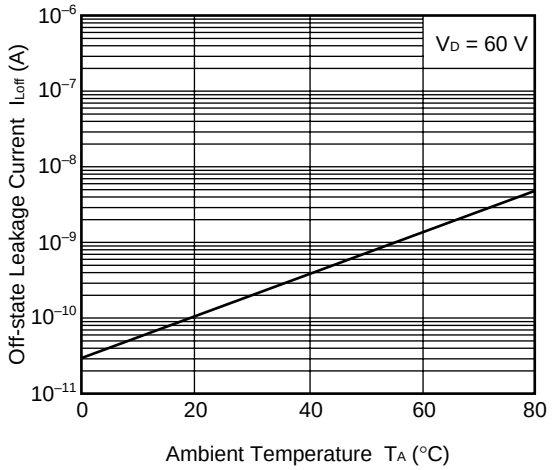
FORWARD VOLTAGE vs. AMBIENT TEMPERATURE



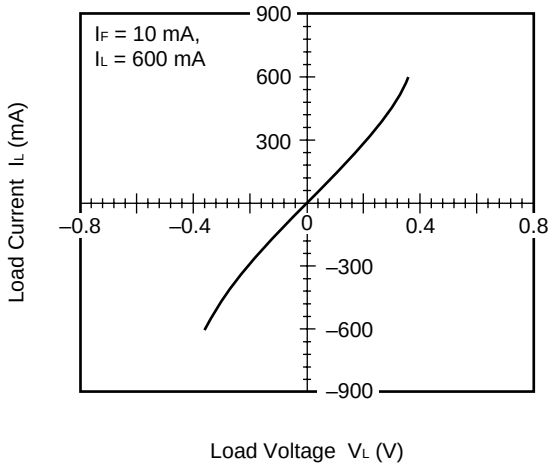
OUTPUT CAPACITANCE vs. APPLIED VOLTAGE



OFF-STATE LEAKAGE CURRENT vs. AMBIENT TEMPERATURE

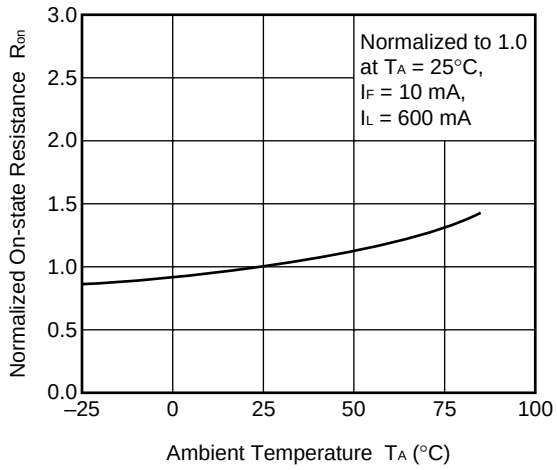


LOAD CURRENT vs. LOAD VOLTAGE

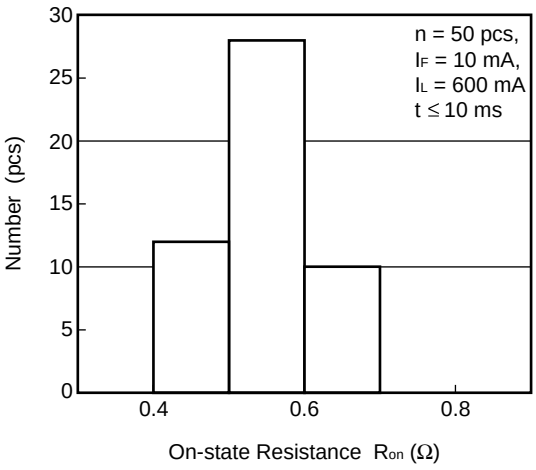


Remark The graphs indicate nominal characteristics.

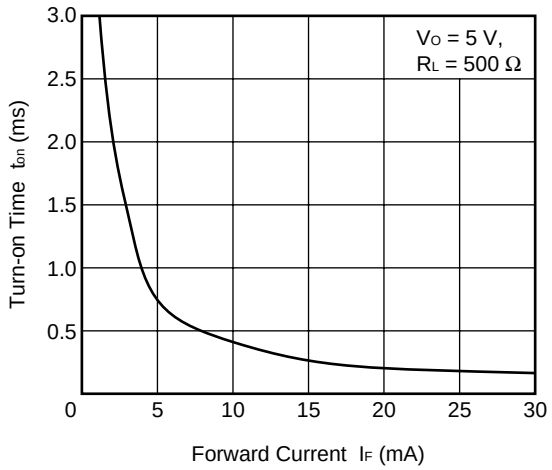
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



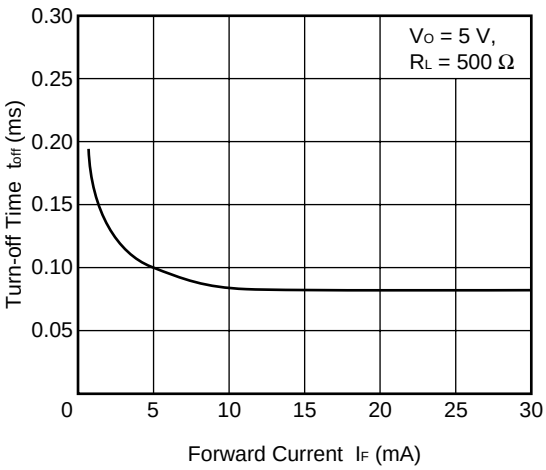
ON-STATE RESISTANCE DISTRIBUTION



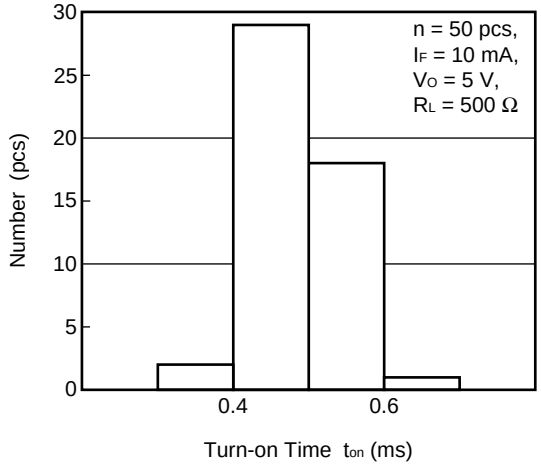
TURN-ON TIME vs. FORWARD CURRENT



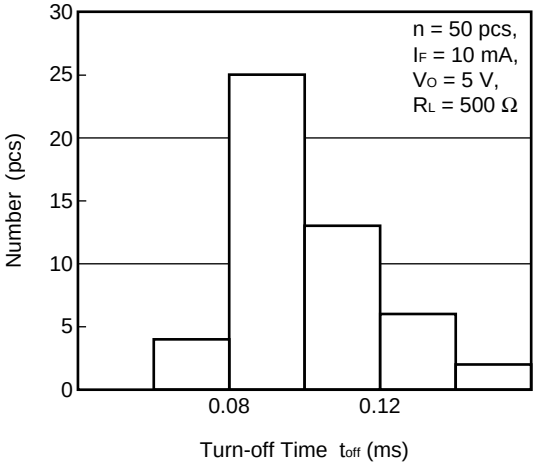
TURN-OFF TIME vs. FORWARD CURRENT



TURN-ON TIME DISTRIBUTION

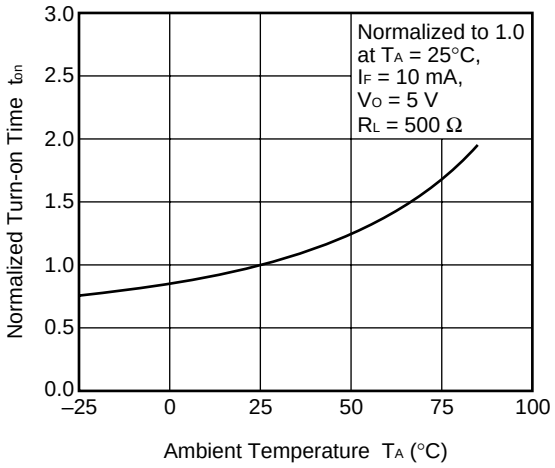


TURN-OFF TIME DISTRIBUTION

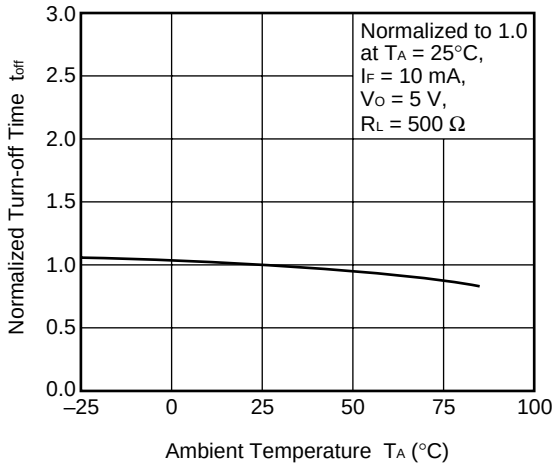


Remark The graphs indicate nominal characteristics.

NORMALIZED TURN-ON TIME vs.
AMBIENT TEMPERATURE



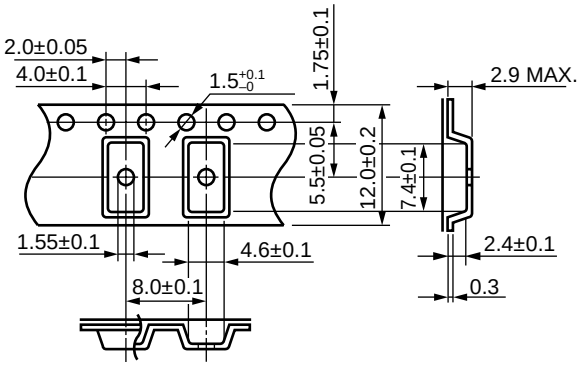
NORMALIZED TURN-OFF TIME vs.
AMBIENT TEMPERATURE



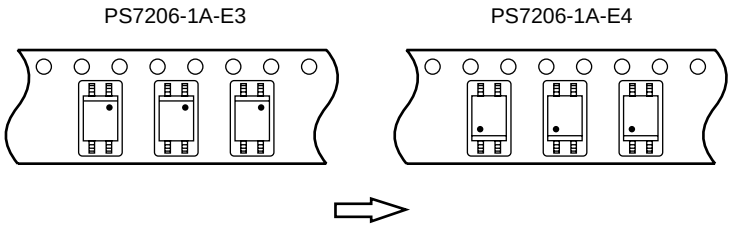
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (in millimeters)

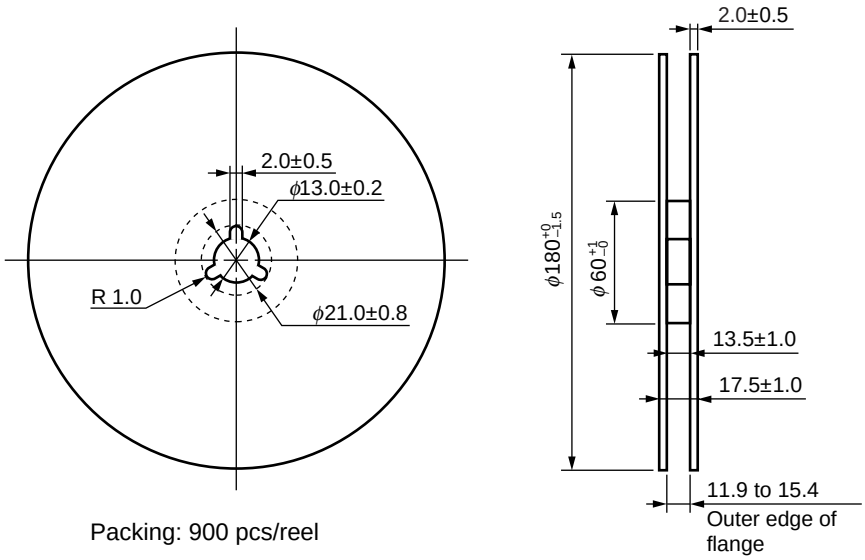
Outline and Dimensions (Tape)



Tape Direction

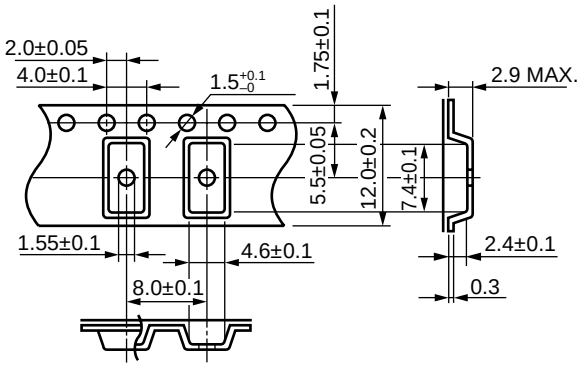


Outline and Dimensions (Reel)

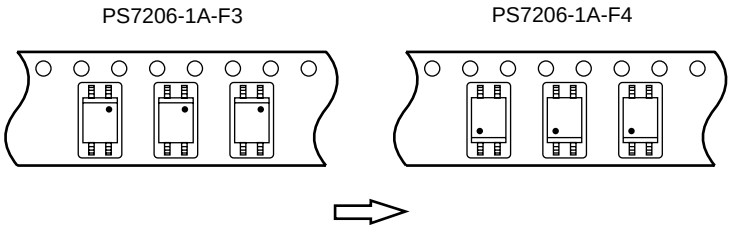


Packing: 900 pcs/reel

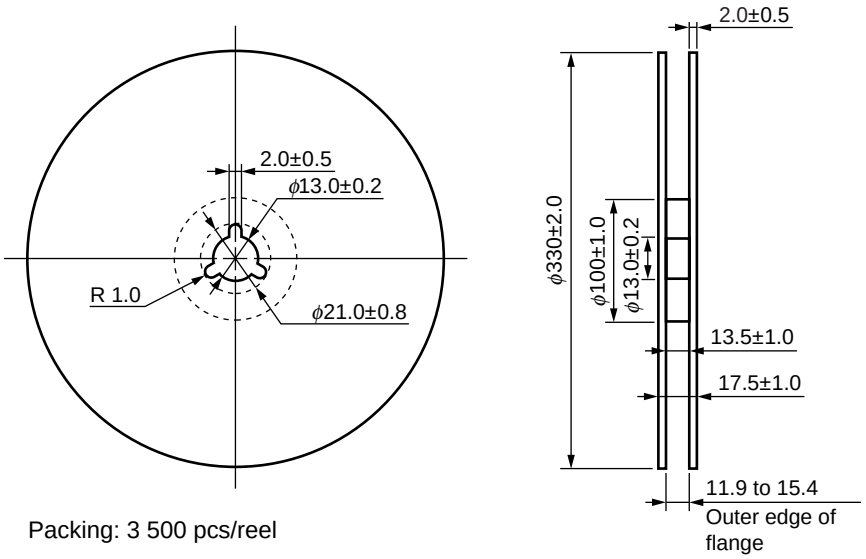
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



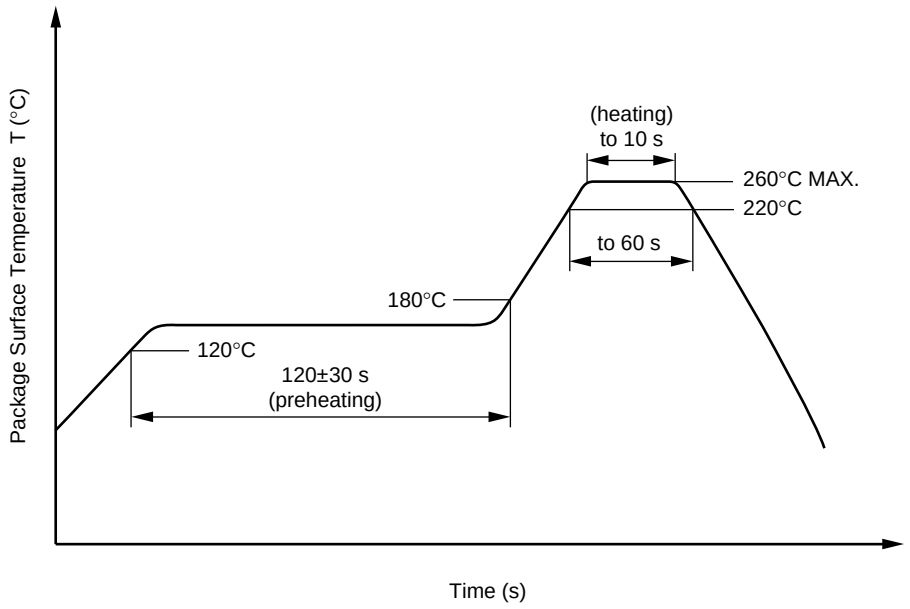
Packing: 3 500 pcs/reel

RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

• Peak reflow temperature	260°C or below (package surface temperature)
• Time of peak reflow temperature	10 seconds or less
• Time of temperature higher than 220°C	60 seconds or less
• Time to preheat temperature from 120 to 180°C	120±30 s
• Number of reflows	Three
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature	260°C or below (molten solder temperature)
• Time	10 seconds or less
• Preheating conditions	120°C or below (package surface temperature)
• Number of times	One
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by soldering iron

• Peak temperature (lead part temperature)	350°C or below
• Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.

(b) Please be sure that the temperature of the package would not be heated over 100°C.

(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

USAGE CAUTIONS

1. Protect against static electricity when handling.
2. Avoid storage at a high temperature and high humidity.

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M8E 02. 11-1

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